



FLIP CHIP MODULES TEST SPECS

TYPE: R 107
#002
INVERTER BOARD

3/1/66

TEST	CONDITION	MINIMUM	MAXIMUM
LOWER LEVEL	$V_{IN} = 0.3V$	-3.2 V	-3.9 V
LOAD CURRENT	$V_{IN} = 0.3 V$	1.9 MA	2.2 MA
V_{CE} (SATURATION)	20 MA LOAD TO - 15 V	\leq	160 MV
TTT	RISE	20 MA LOAD TO - 15 V	\leq 110 NS
	FALL	DRIVE INPUT AT 2MC, FROM FF 1201, OUTPUT HAS CLAMP LOAD.	\leq 170 NS

TECHNICAL INFORMATION

Instruction literature and technical bulletins are available on all digital products, if you would like to be added to our mailing list for this type of material or if you have any questions about the equipment you have purchased, please contact the nearest Digital Sales Office.

MAINTENANCE INFORMATION

Repair of printed circuitry should be done with a low voltage, fairly cool soldering iron to prevent damage to the transistors and keep the copper from lifting. Oscilloscopes used to troubleshoot a module or system should be grounded to prevent damaging transients.

12/1/64

DAW